

SANYO Semiconductors **DATA SHEET**

LC863864B, LC863856B LC863848B, LC863840B LC863832B, LC863828B LC863824B, LC863820B LC863816B

CMOS IC
64K/56K/48K/40K/32K/28K/24K/20K/16K-byte ROM,
CGROM16K-byte
on-chip 768-byte RAM and 352×9-bit OSD RAM
8-bit 1-chip Microcontroller

Overview

The LC863864B/56B/48B/40B/32B/28B/24B/20B/16B are 8-bit single chip microcontrollers with the following on-chip functional blocks :

• CPU: Operable at a minimum bus cycle time of 0.424µs

• On-chip ROM capacity

Program ROM: 64K/56K/48K/40K/32K/28K/24K/20K/16K-bytes

CGROM: 16K-bytes
• On-chip RAM capacity: 768-bytes

• OSD RAM : 352 × 9-bits

- Closed-Caption TV controller and the on-screen display controller
- Closed-Caption data slicer
- Four channels × 8-bit AD Converter
- Three channels × 7-bit PWM
- Two 16-bit timer/counter, 14-bit base timer
- 8-bit synchronous serial interface circuit
- IIC-bus compliant serial interface circuit (Multi-master type)

Continued on next page.

Note: This product includes the IIC bus interface circuit. If you intend to use the IIC bus interface, please notify us of this in advance of our receiving your program ROM code order.

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- ROM correction function
- 16-source 10-vectored interrupt system
- Integrated system clock generator and display clock generator

Only one X'tal oscillator (32.768kHz) for PLL reference is used for both generators

TV control and the closed caption function

All of the above functions are fabricated on a single chip.

Features

■ Read-only memory (ROM) : 65536×8 -bits / 57344×8 -bits / 49152×8 -bits /

 40960×8 -bits / 32768×8 -bits / 28672×8 -bits /

 24576×8 -bits / 20480×8 -bits / 16384×8 -bits for program

16128 × 8-bits for CGROM

 \blacksquare Random access memory (RAM) : 768 × 8-bits (including 128 bytes for ROM correction function)

 352×9 -bits (for CRT display)

■OSD functions

• Screen display: 36 characters × 16 lines (by software)

• RAM : 352 words (9-bits per word)

Display area: $36 \text{ words} \times 8 \text{ lines}$ Control area: $8 \text{ words} \times 8 \text{ lines}$

Characters

Up to 252 kinds of 16×32 dot character fonts (4 characters including 1 test character are not programmable) Each font can be divided into two parts and used as two fonts: a 16×17 dot and 8×9 dot character font At least 111 characters need to be divide to display the caption fonts.

• Various character attributes

Character colors : 16 colors Character background colors : 16 colors Fringe/shadow colors : 16 colors Full screen colors : 16 colors

Rounding Underline

Italic character (slanting)

- Attribute can be changed without spacing
- Vertical display start line number can be set for each row independently (Rows can be overlapped)
- Horizontal display start position can be set for each row independently
- Horizontal pitch (9 to 16 dots) *1 and vertical pitch (1 to 32 dots) can be set for each row independently
- Different display modes can be set for each row independently

Caption • Text mode/OSD mode 1/OSD mode 2 (Quarter size) /Simplified graphic mode

Ten character sizes *1

Horez.
$$\times$$
 Vert. = (1×1) , (1×2) , (2×2) , (2×4) , (0.5×0.5) (1.5×1) , (1.5×2) , (3×2) , (3×4) , (0.75×0.5)

- Shuttering and scrolling on each row
- Simplified graphic display
- *1 Note: Range depends on display mode: refer to the manual for details.
- ■Data Slicer (closed caption format)
 - Closed caption data and XDS data extraction
 - NTSC/PAL, and extracted line can be specified

■Bus Cycle Time/Instruction-Cycle Time

	<u> </u>				
Bus cycle time	e Instruction cycle time Clock divider System clock oscillation		System clock oscillation	Oscillation frequency	Voltage
0.424μs	0.848µs	Internal VCO (Ref : X'tal 32.768kHz)		14.156MHz	4.5V to 5.5V
7.5µs	15.0μs	1/2	Internal RC	800kHz	4.5V to 5.5V
91.55μs	183.1μs	1/1	Crystal	32.768kHz	4.5V to 5.5V
183.1μs	366.2μs	1/2	Crystal	32.768kHz	4.5V to 5.5V

■Ports

• Input/Output Ports : 5 ports (28 terminals)
Data direction programmable in nibble units : 1 port (8 terminals)

(If the N-ch open drain output is selected by option, the corresponding port data can be read in output mode.)

Data direction programmable for each bit individually: 4 ports (20 terminals)

■AD converter

• 4-channels × 8-bit AD converters

■Serial interfaces

• IIC-bus compliant serial interface (Multi-master type)

Consists of a single built-in circuit with two I/O channels. The two data lines and two clock lines can be connected internally.

• Synchronous 8-bit serial interface

■PWM output

• 3-channels × 7-bit PWM

■Timer

• Timer 0 : 16-bit timer/counter

With 2-bit prescaler + 8-bit programmable prescaler

Mode 0: Two 8-bit timers with a programmable prescaler

Mode 1: 8-bit timer with a programmable prescaler + 8-bit counter

Mode 2: 16-bit timer with a programmable prescaler

Mode 3: 16-bit counter

The resolution of timer is 1 tCYC.

• Timer 1: 16-bit timer/ PWM

Mode 0: Two 8-bit timers

Mode 1:8-bit timer + 8-bit PWM

Mode 2: 16-bit timer

Mode 3: Variable-bit PWM (9 to 16 bits)

In mode0/1, the resolution of Timer1/PWM is 1 tCYC

In mode2/3, the resolution is selectable by program; tCYC or 1/2 tCYC

Base timer

Generate every 500ms overflow for a clock application

(using 32.768kHz crystal oscillation for the base timer clock)

Generate every 976µs, 3.9ms, 15.6ms, 62.5ms overflow

(using 32.768kHz crystal oscillation for the base timer clock)

Clock for the base timer is selectable from 32.768kHz crystal oscillation, system clock or programmable prescaler output of Timer 0

- ■Remote control receiver circuit (connected to the P73/INT3/T0IN terminal)
 - Noise rejection function
 - Polarity switching

■Watchdog timer

External RC circuit is required

Interrupt or system reset is activated when the timer overflows

■ROM correction function

Max 128-bytes/2 addresses

■Interrupts

- 16 sources 10 vectored interrupts
 - 1. External Interrupt INTO
 - 2. External Interrupt INT1
 - 3. External Interrupt INT2, Timer/counter T0L (Lower 8-bits)
 - 4. External Interrupt INT3, base timer
 - 5. Timer/counter T0H (Upper 8-bits)
 - 6. Timer T1H, Timer T1L
 - 7. SIO0
 - 8. Data slicer
 - 9. Vertical synchronous signal interrupt (\overline{VS}) , horizontal line (\overline{HS}) , AD
 - 10. IIC, Port 0
- Interrupt priority control

Three interrupt priorities are supported (low, high and highest) and multi-level nesting is possible.

Low or high priority can be assigned to the interrupts from 3 to 10 listed above.

For the external interrupt INTO and INT1, low or highest priority can be set.

■Sub-routine stack level

• A maximum of 128 levels (stack is built in the internal RAM)

■Multiplication/division instruction

- 16-bits × 8-bits (7 instruction cycle times)
- 16-bits ÷ 8-bits (7 instruction cycle times)

■3 oscillation circuits

- Built-in RC oscillation circuit used for the system clock
- Built-in VCO circuit used for the system clock and OSD
- X'tal oscillation circuit used for base timer, system clock and PLL reference

■Standby function

• HALT mode

The HALT mode is used to reduce the power dissipation. In this operation mode, the program execution is stopped. This mode can be released by the interrupt request or the system reset.

• HOLD mode

The HOLD mode is used to stop the oscillations; RC (internal), VCO, and X'tal oscillations.

This mode can be released by the following conditions.

- 1. Pull the reset terminal (\overline{RES}) to low level.
- 2. Feed the selected level to either P70/INT0 or P71/INT1.
- 3. Input the interrupt condition to Port 0.

■Package

- DIP42S (Lead-free type)
- QIP48E (Lead-free type)

■Development tools

Flash EEPROM : LC86F3864AEvaluation chip : LC863096

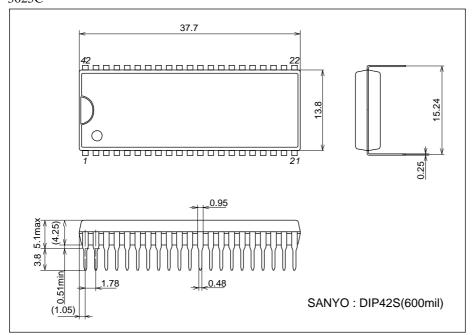
• Emulator : EVA86000 (main) + ECB863200A (evaluation chip board)

+ POD863200 (pod: DIP42S) or POD863201 (QIP48E)

[Shared with LC8632 Series]

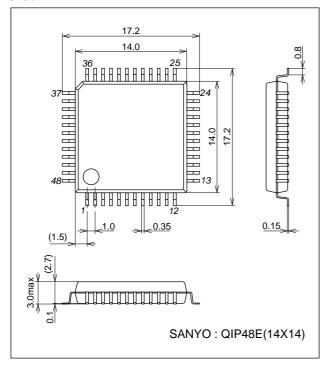
Package Dimensions

unit : mm 3025C

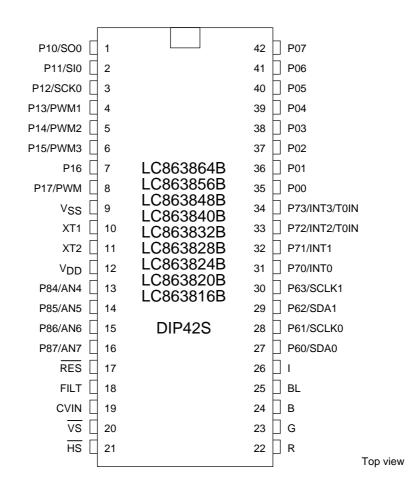


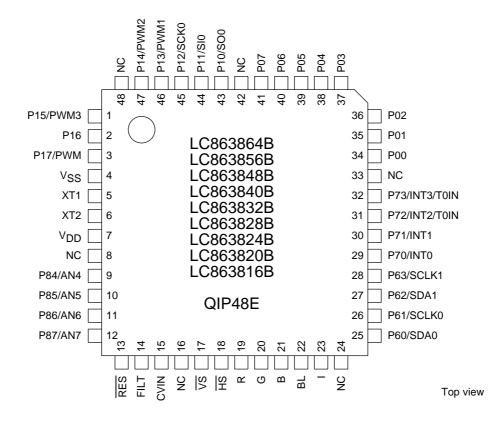
Package Dimensions

unit : mm 3156A

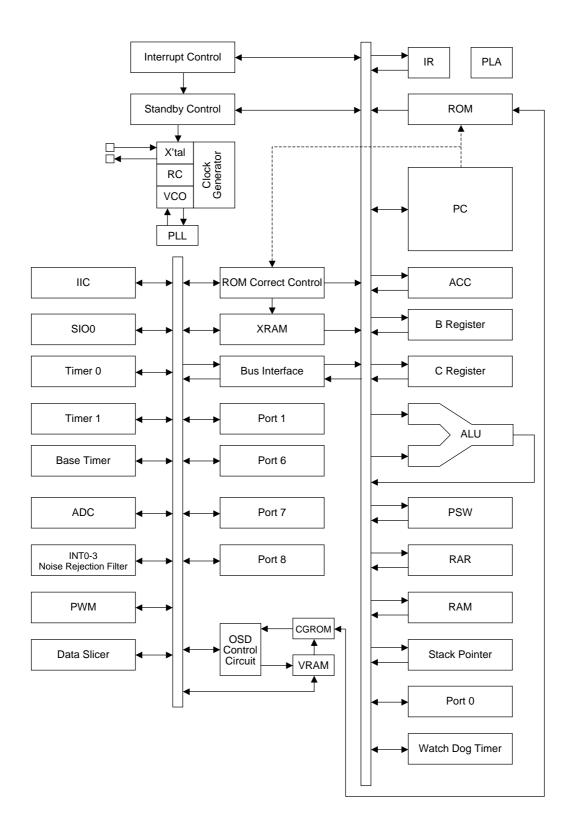


Pin Assignment





System Block Diagram



Pin Description

Terminal	I/O	Function Description	Option
V _{SS}	-	Negative power supply	
XT1	1	Input terminal for crystal oscillator	
XT2	0	Output terminal for crystal oscillator	
V _{DD}	-	Positive power supply	
RES	ı	Reset terminal	
FILT	0	Filter terminal for PLL	
CVIN	ı	Video signal input terminal	
VS	ı	Vertical synchronization signal input terminal	
HS	ı	Horizontal synchronization signal input terminal	
R	0	Red (R) output terminal of RGB image output	
G	0	Green (G) output terminal of RGB image output	
В	0	Blue (B) output terminal of RGB image output	
1	0	Intensity (1) output terminal of RGB image output	
BL	0	Fast blanking control signal	
		Switch TV image signal and caption/OSD image signal	
Port 0	I/O	8-bit input/output port,	Pull-up resistor
P00 to P07		Input/output can be specified in nibble unit Other functions HOLD release input	provided/not provided Output Format CMOS/Nch-OD
		Interrupt input	
Port 1	I/O	8-bit input/output port	Output Format
P10 to P17		Input/output can be specified in a bit	CMOS/Nch-OD
		Other functions P10 SIO0 data output P11 SIO0 data input/bus input/output P12 SIO0 clock input/output P13 PWM1 output P14 PWM2 output P15 PWM3 output P17 Timer1 (PWM) output	
Port 6	I/O	4-bit input/output port	
P60 to P63		Input/output can be specified for each bit Other functions P60 IIC0 data I/O P61 IIC0 clock output P62 IIC1 data I/O P63 IIC1 clock output	

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Terminal	I/O				Fun		Option			
Port 7	I/O	• 4-bit	inpu	t/output po	t					
P70		Input	t or c	utput can b	e specified f					
P71 to P73		• Othe	er fun	ction						
			P70) INTO	input/HOLD					
				Nch-	Tr. output for	r watchdog ti	imer			
			P71	INT1	input/HOLD	release inpu	ut			
			P72	2 INT2	input/Timer	0 event inpu	t			
			P73	INT3	input (noise	rejection filt	er connected	d)/		
		l L		Time	r 0 event inp	ut				
		Interru	ıpt re	ceiver form	at, vector ac	ldresses				
				rising	falling	rising/ falling	H level	L level	vector	
		INTO)	enable	enable	disable	enable	enable	03H	
		INT1	1	enable	enable	disable	enable	enable	0BH	
		INT2	2	enable	enable	enable	disable	disable	13H	
		INT3	3	enable	enable	enable	disable	disable	1BH	
Port 8	I/O	• 4-bit	inpu	t/output po	t					
P84 to P87		Input	Input or output can be specified for each bit							
		• Othe	Other function							
		AD c	AD converter input port (4 lines)							
NC	-	Unuse	ed ter	rminal						
		Leave	ope	n						

- Output form and existence of pull-up resistor for all ports can be specified for each bit.
- Programmable pull-up resistor is always connected regardless of port option, CMOS or N-ch open drain output in port 1.
- Port status in reset

Terminal	Terminal I/O Pull-up resistor status at selecting pull-up option				
Port 0	1	Pull-up resistor OFF, ON after reset release			
Port 1	1	Programmable pull-up resistor OFF			

Absolute Maximum Ratings / Ta = 25°C, $V_{SS} = 0V$

David		O:b l	Dina	0			Li	mits	
Para	ameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Maximum voltage	n supply	V _{DD} max	V _{DD}			-0.3		+6.5	
Input volt	tage	V _I (1)	RES, HS, VS, CVIN			-0.3		V _{DD} +0.3	V
Output vo	oltage	V _O (1)	R, G, B, I, BL, FILT			-0.3		V _{DD} +0.3	
Input/out	put voltage	V _{IO}	Ports 0, 1, 6, 7, 8			-0.3		V _{DD} +0.3	
High level	Peak output	IOPH(1)	Ports 0, 1, 7, 8	CMOS output For each pin.		-4			
output current	current	IOPH(2)	R, G, B, I, BL	CMOS output For each pin.		-5			
	Total	ΣΙΟΑΗ(1)	Ports 0, 1	The total of all pins.		-20			
	output	ΣΙΟΑΗ(2)	Ports 7, 8	The total of all pins.		-10			
	current	ΣΙΟΑΗ(3)	R, G, B, I, BL	The total of all pins.		-15			mA
Low	Peak	IOPL(1)	Ports 0, 1, 6, 8	For each pin.				20	1117
level	output	IOPL(2)	Port 7	For each pin.				15	
output	current	IOPL(3)	R, G, B, I, BL	For each pin.				5	
current	Total	ΣIOAL(1)	Ports 0, 1	The total of all pins.				40	
	output	ΣIOAL(2)	Ports 6, 7, 8	The total of all pins.				40	
	current	ΣIOAL(3)	R, G, B, I, BL	The total of all pins.				15	
Maximum	n power	Pd max	DIP42S	Ta = -10 to +70°C				715	\^/
dissipatio	on		QIP48E					385	mW
Operating temperat	g ure range	Topr				-10		+70	· °C
Storage temperat	ure range	Tstg				-55		+125	30

Recommended Operating Range / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

D	0	Dina	Odisi			Lim	its	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Operating supply	V _{DD} (1)	V_{DD}	0.844μs ≤ tCYC ≤ 0.852μs		4.5		5.5	
voltage range	V _{DD} (2)		4μs ≤ tCYC ≤ 400μs		4.5		5.5	
Hold voltage	V _{HD}	V _{DD}	RAMs and the registers data are kept in HOLD mode.		2.0		5.5	
High level input	V _{IH} (1)	Port 0 (Schumitt)	Output disable	4.5 to 5.5	0.6V _{DD}		V _{DD}	
voltage	V _{IH} (2)	Ports 1, 6 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	0.75V _{DD}		V _{DD}	V
	V _{IH} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{DD} -0.5		V _{DD}	
	V _{IH} (4)	Port 8 Watchdog timer input	Output disable	4.5 to 5.5	0.7V _{DD}		V _{DD}	

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D	O. wash ad	Dia	One distance			Lim	its	
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Low level input	V _{IL} (1)	Port 0 (Schumitt)	Output disable	4.5 to 5.5	V _{SS}		0.2V _{DD}	
voltage	V _{IL} (2)	Ports 1, 6 (Schumitt) Port 7 (Schumitt) port input/interrupt HS, VS, RES (Schumitt)	Output disable	4.5 to 5.5	V _{SS}		0.25V _{DD}	V
	V _{IL} (3)	Port 70 Watchdog timer input	Output disable	4.5 to 5.5	V _{SS}		0.6V _{DD}	
	V _{IL} (4)	Port 8 Watchdog timer input	Output disable	4.5 to 5.5	V _{SS}		0.3V _{DD}	
CVIN	VCVIN	CVIN		5.0	1Vp-p -3dB	1Vp-p	1Vp-p +3dB	Vp-p*
Operation	tCYC(1)		All functions operating	4.5 to 5.5	0.844	0.848	0.852	
cycle time	tCYC(2)		AD converter operating OSD and Data slicer are not operating	4.5 to 5.5	0.844		30	μs
	tCYC(3)		OSD, AD converter and Data slicer are not operating	4.5 to 5.5	0.844		400	
Oscillation frequency range	FmRC		Internal RC oscillation	4.5 to 5.5	0.4	0.8	3.0	MHz

^{*} Vp-p : Peak-to-peak voltage

Electrical Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Parameter	Symbol	Pins	Conditions			Limi	ts	
Parameter	Symbol	PIIIS	Conditions	V _{DD} [V]	min	typ	max	unit
High level input current	I _{IH} (1)	Ports 0, 1, 6, 7, 8	Output disable Pull-up MOS Tr. OFF VIN = VDD (Including the off-leak current of the output Tr.)	4.5 to 5.5			1	
	I _{IH} (2)	• RES • HS, VS	• V _{IN} = V _{DD}	4.5 to 5.5			1	
Low level input current	I _{IL} (1)	Ports 0, 1, 6, 7, 8	Output disable Pull-up MOS Tr. OFF VIN = VSS (Including the off- leak current of the output Tr.)	4.5 to 5.5	-1			μА
	I _{IL} (2)	• RES • HS, VS	V _{IN} = V _{SS}	4.5 to 5.5	-1			
High level output voltage	V _{OH} (1)	• CMOS output of ports 0, 1, 71 to 73, 8	I _{OH} = -1.0mA	4.5 to 5.5	V _{DD} -1			
	V _{OH} (2)	R, G, B, I, BL	$I_{OH} = -0.1 \text{mA}$	4.5 to 5.5	V _{DD} -0.5			
Low level	V _{OL} (1)	Ports 0, 1, 71 to 73, 8	I _{OL} = 10mA	4.5 to 5.5			1.5	
output voltage	V _{OL} (2)	Ports 0, 1, 71 to 73, 8	I _{OL} = 1.6mA	4.5 to 5.5			0.4	V
	V _{OL} (3)	• R, G, B, I, BL • Port 6	I _{OL} = 3.0mA	4.5 to 5.5			0.4	
	V _{OL} (4)	Port 6	$I_{OL} = 6.0 \text{mA}$	4.5 to 5.5			0.6	
	V _{OL} (5)	Port 70	I _{OL} = 1mA	4.5 to 5.5			0.4	
Pull-up MOS Tr. resistance	Rpu	• Ports 0, 1, 7, 8	$V_{OH} = 0.9V_{DD}$	4.5 to 5.5	13	38	80	kΩ
Bus terminal short circuit resistance (SCL0 to SCL1, SDA0 to SDA1)	RBS	• P60 to P62 • P61 to P63		4.5 to 5.5		130	300	Ω

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Dorometer		Pins	Conditions		Limits				
Parameter	Symbol	PIIIS	Conditions	V _{DD} [V]	min	typ	max	unit	
Hysteresis voltage	VHIS	• Ports 0, 1, 6, 7 • RES • HS, VS	Output disable	4.5 to 5.5		0.1V _{DD}		V	
Input clump voltage	VCLMP	CVIN		5.0	2.3	2.5	2.7		
Pin capacitance	СР	All pins	f = 1MHz Every other terminals are connected to V _{SS} . Ta = 25°C	4.5 to 5.5		10		pF	

Serial Input/Output Characteristics at $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

	D-		Ol	Dina	O a malistica a a		-,	Ratings		unit
	Pa	arameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
		Cycle	tCKCY(1)	•SCK0	Refer to figure 4.		2			
	Input clock	Low Level pulse width	tCKL(1)	•SCLK0		4.5 to 5.5	1			
Serial clock	dul	High Level pulse width	tCKH(1)				1			tCYC
erial	~	Cycle	tCKCY(2)	•SCK0	Use pull-up		2			ICTC
S	Low Level pulse width High Level pulse width		tCKL(2)	•SCLK0	resistor (1kΩ) when Nch open-	4.5 to 5.5		1/2tCKCY		
			tCKH(2)		drain output. • Refer to figure 4.			1/2tCKCY		
Serial input	Data	set up time	tICK	SI0	Data set-up to SCK0. Data hold from		0.1			
Serial	Data	hold time	tCKI		SCK0. • Refer to figure 4.	4.5 to 5.5	0.1			
=		ut delay time ng external clock)	tCKO(1)	SO0	Data hold from SCK0.	4.5 to 5.5			7/12tCYC +0.2	μs
Serial outpu	Output delay time (Using internal clo		tCKO(2)	SO0	Use pull-up resistor (1kΩ) when Nch opendrain output. Refer to figure 4.	4.5 to 5.5			1/3tCYC +0.2	

IIC Input/Output Conditions / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

	0 1 1	Star	ndard	High	speed	
Parameter	Symbol	min	max	min	max	unit
SCL frequency	fSCL	0	100	0	400	kHz
BUS free time between stop to start	tBUF	4.7	-	1.3	-	μs
HOLD time of start, restart condition	tHD ; STA	4.0	-	0.6	-	μs
L time of SCL	tLOW	4.7	-	1.3	-	μs
H time of SCL	tHIGH	4.0	-	0.6	-	μs
Set-up time of restart condition	tSU; STA	4.7	-	0.6	-	μs
HOLD time of SDA	tHD ; DAT	0	-	0	0.9	μs
Set-up time of SDA	tSU; DAT	250	-	100	-	ns
Rising time of SDA, SCL	tR	-	1000	20 + 0.1Cb	300	ns
Falling time of SDA, SCL	tF	-	300	20 + 0.1Cb	300	ns
Set-up time of stop condition	tSU; STO	4.0	-	0.6	-	μs

Refer to figure 10

Note: Cb: Total capacitance of all BUS (unit: pF)

Pulse Input Conditions / Ta = -10°C to +70°C, $V_{SS} = 0V$

Doromotor	Cumphal	Pins	Conditions			Limi	ts	
Parameter	Symbol	PINS	Conditions	V _{DD} [V]	min	typ	max	unit
High/low level pulse width	tPIH(1) tPIL(1)	•INT0, INT1 •INT2/T0IN	Interrupt acceptable Timer 0-countable	4.5 to 5.5	1			
	tPIH(2) tPIL(2)	INT3/T0IN (1 tCYC is selected for noise rejection clock.)	Interrupt acceptable Timer 0-countable	4.5 to 5.5	2			
	tPIH(3) tPIL(3)	INT3/T0IN (16 tCYC is selected for noise rejection clock.)	Interrupt acceptable Timer 0-countable	4.5 to 5.5	32			tCYC
	tPIH(4) tPIL(4)	INT3/T0IN (64 tCYC is selected for noise rejection clock.)	Interrupt acceptable Timer 0-countable	4.5 to 5.5	128			
	tPIL(5)	RES	Reset acceptable	4.5 to 5.5	200			
	tPIH(6) tPIL(6)	HS, VS	Display position controllable The active edge of HS and VS must be apart at least 1 tCYC. Refer to figure 6.	4.5 to 5.5	3			μs
Rising/falling time	tTHL tTLH	HS	Refer to figure 6.	4.5 to 5.5			500	ns

AD Converter Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

Deremeter	O. made ad	Din	Conditions		Limits			
Parameter	Symbol	Pins	Conditions	V _{DD} [V]	min	typ	max	unit
Resolution	N					8		bit
Absolute precision	ET		(Note 3)				±1.5	LSB
Conversion time	tCAD		ADCR2=0 (Note 4)	4.5 to 5.5		16		10)(0
			ADCR2=1 (Note 4)			32		tCYC
Analog input voltage range	VAIN	AN4 to AN7		4.0 to 0.0	V _{SS}		V _{DD}	V
Analog port input current	IAINH		VAIN = V _{DD}				1	
	IAINL		VAIN = V _{SS}		-1			μΑ

Note 3: Absolute precision does not include quantizing error (1/2LSB).

Note 4: Conversion time is the time till the complete digital conversion value for analog input value is set to a register after the instruction to start conversion is sent.

Current Dissipation Characteristics / $Ta = -10^{\circ}C$ to $+70^{\circ}C$, $V_{SS} = 0V$

The sample current dissipation characteristics is the measurement result of SANYO provided evaluation board when the recommended circuit parameters shown in the sample oscillation circuit characteristics are used externally. The

currents through the output transistors and the pull-up MOS transistors are ignored.

Parameter	Symbol	Pins	Conditions		Limits				
Farameter			Conditions	V _{DD} [V]		typ	max	unit	
Current dissipation during basic operation (Note 5)	IDDOP(1)	V _{DD}	FmX'tal=32.768kHz X'tal oscillation System clock : VCO VCO for OSD operating Internal RC oscillation stops	4.5 to 5.5		10	24	mA	
	IDDOP(2)		FmX'tal=32.768kHz X'tal oscillation System clock: X'tal (Instruction cycle time: 366.2µs) VCO for system, VCO for OSD, Internal RC oscillation stop Data slicer, AD converters stop	4.5 to 5.5		55	300	μА	
Current dissipation in HALT mode (Note 5)	IDDHALT(1)		HALT mode FmX'tal=32.768kHz X'tal oscillation System clock: VCO VCO for OSD stops Internal RC oscillation stops	4.5 to 5.5		3	9	mA	
	IDDHALT(2)		HALT mode FmX'tal=32.768kHz X'tal oscillation VCO for system stops VCO for OSD stops System clock: Internal RC	4.5 to 5.5		300	1000		
	IDDHALT(3)		HALT mode FmX'tal=32.768kHz X'tal oscillation VCO for system stops VCO for OSD stops System clock: X'tal (Instruction cycle time: 366.2µs)	4.5 to 5.5		45	200	μА	
Current dissipation in HOLD mode (Note 5)	IDDHOLD		HOLD mode All oscillation stops.	4.5 to 5.5		0.05	20		

(Note 5) The currents through the output transistors and the pull-up MOS transistors are ignored.

Recommended Oscillation Circuit and Sample Characteristics

The sample oscillation circuit characteristics in the table below is based on the following conditions:

- Recommended circuit parameters are verified by an oscillator manufacturer using a SANYO provided oscillation evaluation board.
- Sample characteristics are the result of the evaluation with the recommended circuit parameters connected externally.

Recommended oscillation circuit and sample characteristics ($Ta = -10 \text{ to } +70^{\circ}\text{C}$)

Frequency	Manufacturer	Oscillator	Reco	mmended o	circuit param	Operating supply	Oscillation stabilizing time		Notes	
			C1	C2	Rf	Rd	voltage range	typ	max	
32.768kHz	Seiko Epson	C-002RX	18pF	18pF	OPEN	390kΩ	4.5 to 5.5V	1.0s	1.5s	

Notes: The oscillation stabilizing time period is the time until the VCO oscillation for the internal system becomes stable after the following conditions. (Refer to Figure 2.)

- 1. The V_{DD} becomes higher than the minimum operating voltage after the power is supplied.
- 2. The HOLD mode is released.

The sample oscillation circuit characteristics may differ applications.

For further assistance, please contact with oscillator manufacturer with the following notes in your mind.

- Since the oscillation frequency precision is affected by wiring capacity of the application board, etc., adjust the oscillation frequency on the production board.
- The above oscillation frequency and the operating supply voltage range are based on the operating temperature of -10°C to +70°C. For the use with the temperature outside of the range herein, or in the applications requiring high reliability such as car products, please consult with oscillator manufacturer.
- When using the oscillator which is not shown in the sample oscillation circuit characteristics, please consult with SANYO sales personnel.

Since the oscillation circuit characteristics are affected by the noise or wiring capacity because the circuit is designed with low gain in order to reduce the power dissipation, refer to the following notices.

- The distance between the clock I/O terminal (XT1 terminal XT2 terminal) and external parts should be as short as possible.
- The capacitors' VSS should be allocated close to the microcontroller's GND terminal and be away from other GND.
- The signal lines with rapid state changes or with large current should be allocated away from the oscillation circuit.

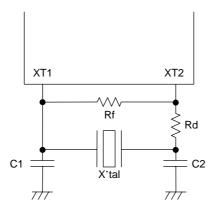
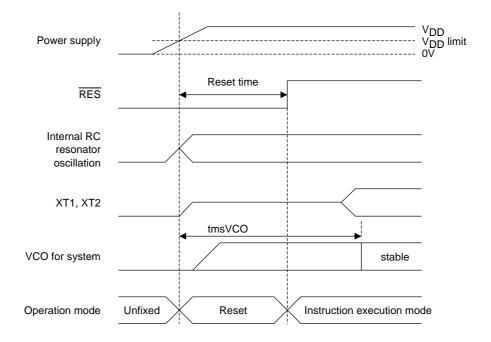
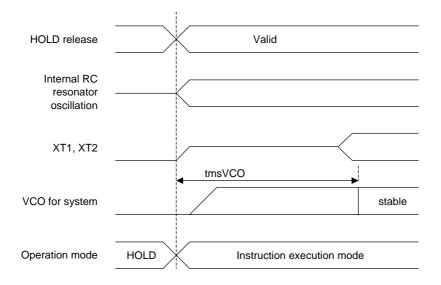


Figure 1 Recommended oscillation circuit

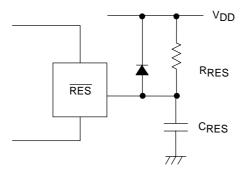


<Reset time and oscillation stabilizing time>



<HOLD release signal and oscillation stabilizing time>

Figure 2 Oscillation stabilizing time



(Note) Determine the CRES, RRES value to generate more than $200\mu s$ reset time.

Figure 3 Reset circuit



<AC timing measurement point>

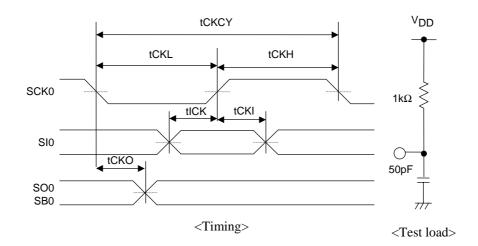


Figure 4 Serial input / output test condition

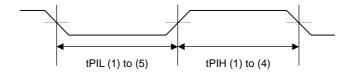


Figure 5 Pulse input timing condition - 1

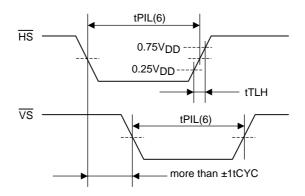


Figure 6 Pulse input timing condition - 2

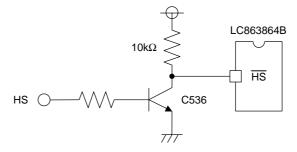
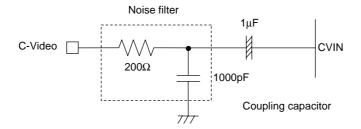


Figure 7 Recommended Interface circuit



Output impedance of C-Video before Noise filter should be less then 100 $\!\Omega$. Figure 8 CVIN recommended circuit

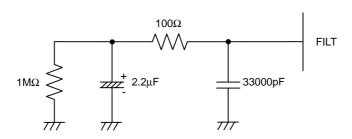
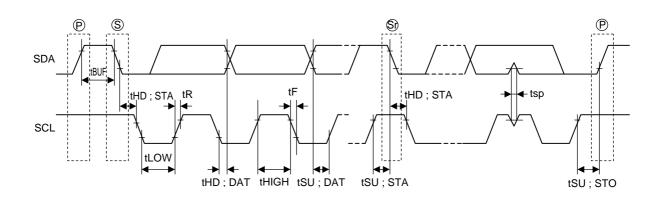


Figure 9 FILT recommended circuit

Note: Place FILT parts on board as close to the microcontroller as possible.



S: start conditionP: stop conditionSr: restart condition

tsp: Spike suppression

Standard mode : not exist High speed mode : less than 50ns

Figure 10 IIC timing

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